Overview

HP EliteOne 1000 G1 All-in-One Business PC



HP EliteOne 1000 G1 AiO Front

- 1. Webcam (optional)
- 2. Speakers (optional)
- 3. Volume slider

- 4. Collaboration keys
- 5. On-screen display (OSD) buttons
- 6. Power button

Overview



HP EliteOne 1000 G1 AiO Collaboration Keys

- 1. Volume slider
- 2. Speaker mute button
- 3. Hang up button
- 4. Webcam mute button

- 5. Microphone mute button
- 6. Call button
- 7. Power button

Features



HP EliteOne 1000 G1 AiO Rear

- 1. Security lock slot
- 2. RJ-45 (network) jack
- 3. Power connector
- 4. DisplayPort™ 1.2 in

- 5. DisplayPort™ 1.2 out
- 6. HDMI in connector
- 7. USB 3.1 Gen 1 ports
- 8. USB 3.1 Gen 1 ports (wake capable)



Features

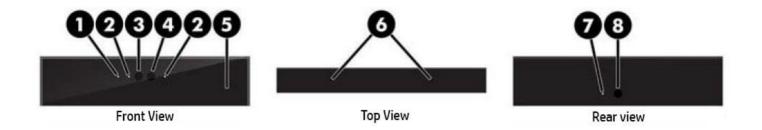


HP EliteOne 1000 G1 AiO Side

- 1. USB 3.1 Gen 1 Type-A (charging) port
- 2. USB 3.1 Type-C Gen 1 port

- 3. Universal Audio Jack with CTIA headset support
- 4. Fingerprint sensor (optional)

Features



HP EliteOne 1000 G1 AiO and HP EliteOne 1000 Display Infrared (IR) and Dual-facing Full High Definition (FHD) webcam (optional)

- 1. Webcam light
- 2. IR light
- 3. Full High Definition (FHD) webcam
- 4. IR webcam

- 5. Rear webcam adjustment wheel
- 6. Digital microphones
- 7. Webcam light
- 8. FHD webcam



HP EliteOne 1000 G1 AiO and HP EliteOne 1000 Display Full High Definition (FHD) webcam (optional)

- 1. Webcam light
- FHD webcam

3. Digital microphones

Features

HP EliteOne 1000 Displays

Additional optional displays include

HP EliteOne 1000 23.8-in FHD Display
HP EliteOne 1000 23.8-in FHD Touch Display
HP EliteOne 1000 27-in 4K UHD Display
HP EliteOne 1000 34-in WQHD Curved Display

^{*} Separately purchased, interchangeable displays in sizes 23.8" (60.45 cm), 27" (68.58 cm) and 34" (86.36 cm) diagonal are planned to be available after launch in November 2017.



HP EliteOne 1000 Display Front

Webcam (optional)

2. On-screen display (OSD) buttons



Features



HP EliteOne 1000 Display Rear

- 1. Power button
- 2. DisplayPort™ 1.2 in
- 3. HDMI in connector

- 4. Power connector
- 5. USB Type-B out (webcam, mics, and touch)
- 6. Security lock slot

Features



HP EliteOne 1000 Display Side

Features

At a Glance

- New All-in-One form factor with interchangeable and upgradeable display options¹
- New commercial ID with 23.8" FHD Touch and Non-touch, 27" 4K UHD, and 34" WQHD Curved² display options
- Ability to redeploy displays or purchase additional displays¹ with a matching standalone display base
- Tool-less accessibility to easily reach upgradeable components or swap displays¹
- Creates a rich video conferencing solution with immersive video and audio engagement, capacitive touch collaboration keys, and a built-in pop-up privacy camera
- Integrated collaboration keys keep conferencing controls (call answer, microphone mute, webcam disable, call hang up, and volume controls) within reach
- Intel® Q270 chipset supporting Intel® 7th generation Core™ processors and Intel® 6th generation Core™ processors,
 featuring integrated Intel® HD Graphics and Intel® vPro™ Technology (available with Core i5 and Core i7 processors)
- 65W processor support
- Support for Windows 10 with Intel® 7th Generation processors
- Support for Windows 10 to Windows 7 Downgrade with Intel® 6th Generation processors
- Intel® HD graphics
- Intel® Ethernet Connection I219LM GbE LOM integrated network connection
- DDR4 Synchronous Dynamic Random Access Memory (SDRAM)
- Support for up to 2 additional monitors via DisplayPort™ 1.2 (1) or HDMI connector (1)
- HP Sure Start Gen3³
- HP Manageability Integration Kit⁴
- HP PhoneWise⁶; A phone integration solution that allows you to route phone calls and answer texts on your
- ENERGY STAR® certified. EPEAT® Gold registered where applicable/supported. Registration may vary by country. See
 http://www.epeat.net for registration status by country. Search keyword generator on HP's 3rd party option store for
 solar generator accessories at http://www.hp.com/go/options
- CCC Certified
- TCO Edge for AiO
- PC chassis and all internal components and modules are manufactured with low halogen content⁵
- Arsenic-free
- Protected by HP Services, including limited warranties up to 3-3-3 (terms and conditions vary by country; certain restrictions and exclusions apply); Care Packs available with up to 5 years ext Business Day Onsite Hardware Support
- 1. Separately purchased, interchangeable displays in sizes 23.8" (60.45 cm), 27" (68.58 cm) and 34" (86.36 cm) diagonal are planned to be available after launch in November.
- 2. 34" display not available at launch. Planned availability November 2017.
- 3. HP Sure Start G3 requires Intel® 7th generation processors
- 4. HP Management Integration Kit for Microsoft System Center Configuration Manager: HP Management Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html
- 5. External power supplies, power cords, cables and peripherals are not low halogen. Service parts obtained after purchase may not be low halogen.



HP EliteOne 1000 G1 All-in-One Business PC

QuickSpecs

Features

6. HP PhoneWise only available on HP EliteBook 1040, EliteBook x360 1020 and HP EliteOne 1000 AiO platforms. For HP PhoneWise system requirements see: http://www.hp.com/go/HPPhoneWise. HP PhoneWise not compatible with HP WorkWise at launch.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Features

PRODUCT NAMES

HP EliteOne 1000 G1 All-in-One Business PC

- HP EliteOne 1000 G1 23.8-in All-in-One Business PC
- HP EliteOne 1000 G1 23.8-in Touch All-in-One Business PC
- HP EliteOne 1000 G1 27-in 4K UHD All-in-One Business PC
- HP EliteOne 1000 G1 34-in Curved All-in-One Business PC*

OPERATING SYSTEMS

Preinstalled Microsoft Windows® 10 Professional (64 bit)¹

Microsoft Windows® 10 Professional (64 bit) (National Academic License)¹

Microsoft Windows® 10 Home (64 bit)

Microsoft Windows® 10 Home Single Language (64 bit)

Microsoft Windows® 10 Professional (64 bit) downgrade to Windows® 7 (32 bit) Microsoft Windows® 10 Professional (64 bit) downgrade to Windows® 7 (64 bit)

FreeDOS 2.0 NeoKylin Linux® 64²

Web-supported only Microsoft Windows® 10 Enterprise (64 bit)

Microsoft Windows® 7 Enterprise (64 bit)

- Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately
 purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10
 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over
 time for updates. See http://www.windows.com/.
- 2. This system is preinstalled with Windows 7 Pro software and also comes with a license and media for Windows 10 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.



Features

PROCESSORS

Intel® Core™ i7-7700 with Intel® HD Graphics 630 (3.6 GHz, up to 4.2 GHz with Intel® Turbo Boost, 8 MB cache, 4 cores)

Intel® Core™ i5-7500 with Intel® HD Graphics 630 (3.4 GHz, up to 3.8 GHz with Intel® Turbo Boost, 6 MB cache, 4 cores)

Intel® Core™ i5-7600 with Intel® HD Graphics 630 (3.5 GHz, up to 4.1 GHz with Intel® Turbo Boost, 6 MB cache, 4 cores)

Intel® Core™ i3-7100 with Intel® HD Graphics 630 (3.9 GHz, 3 MB cache, 2 cores)

Intel® Core™ i3-7300 with Intel® HD Graphics 630 (4 GHz, 4 MB cache, 2 cores)

Intel® Core™ i3-7320 with Intel® HD Graphics 630 (4.1 GHz, 4 MB cache, 2 cores)

Intel® Pentium® G4560 with Intel® HD Graphics 610 (3.5 GHz, 3 MB cache, 2 cores)

Intel® Pentium® G4600 with Intel® HD Graphics 630 (3.6 GHz, 3 MB cache, 2 cores)

Intel® Pentium® G4620 with Intel® HD Graphics 630 (3.7 GHz, 3 MB cache, 2 cores)

Intel® Celeron™ G3930 with Intel® HD Graphics 610 (2.9 GHz, 2 MB cache, 2 cores)

Intel® Celeron™ G3950 with Intel® HD Graphics 610 (3.0 GHz, 2 MB cache, 2 cores)

Intel® Core™ i7-6700 with Intel® HD Graphics 530 (3.4 GHz, up to 4 GHz with Intel® Turbo Boost, 8 MB cache, 4 cores)

Intel® Core™ i5-6500 with Intel® HD Graphics 530 (3.2 GHz, up to 3.6 GHz with Intel® Turbo Boost, 6 MB cache, 4 cores)

Intel® Core™ i5-6600 with Intel® HD Graphics 530 (3.3 GHz, up to 3.9 GHz with Intel® Turbo Boost, 6 MB cache, 4 cores)

Intel® Core™ i3-6100 with Intel® HD Graphics 530 (3.7 GHz, 3 MB cache, 2 cores)

Intel® Pentium® G4440 with Intel® HD Graphics 510 (3.3 GHz, 3 MB cache, 2 cores)

Intel® Celeron™ G3900 with Intel® HD Graphics 510 (2.8 GHz, 2 MB cache, 2 cores)

Processors Family

Intel® 7th Generation Core™ Processors

Intel® 6th Generation Core™ Processors

NOTE: Your product does not support Windows 8 or Windows 7, In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com **NOTE:** Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. 64-bit computing system required. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel®'s numbering is not a measurement of higher performance.

CHIPSET

Intel® Q270



Features

GRAPHICS

Integrated

Intel® HD graphics1,2

Intel® HD Graphics 530 (integrated on 6th gen Core i7/i5/i3 processors)

Intel® HD Graphics 510 (integrated on 6th gen Pentium G4400 and Celeron G3900)

Intel® HD Graphics 630 (integrated on 7th gen Core i7/i5/i3 processors and Pentium G4620, 4600)

Intel® HD Graphics 610 (integrated on Pentium® G4560, Celeron® G3950, G3930)

- 1. HD content required to view HD images.
- 2. Integrated Intel Wi-Di software is available on select models only and requires separately purchased projector, to or computer monitor with an integrated or external Wi-Di receiver. External Wi-Di receivers connect to the projector, to or computer monitor via a standard VGA, HDMI cable, also sold separately

DISPLAYS

HP EliteOne 1000 23.8-in FHD Display¹

23.8" diagonal IPS widescreen WLED backlit anti-glare LCD (1920 x 1080)²

Non-Touch

Tilt: 5 degrees forward and 25 degrees back

Height Adjustment: 40mm

HP EliteOne 1000 23.8-in FHD Touch Display¹

23.8" diagonal IPS widescreen WLED backlit anti-glare LCD (1920 x 1080)²

Touch; Projected capacitive in-cell touch supports up to 10 touch-points

Tilt: 5 degrees forward and 25 degrees back

Height Adjustment: 40mm

HP EliteOne 1000 27-in 4K UHD Display¹

27" diagonal IPS widescreen WLED backlit anti-glare 4K UHD LCD (3840 x 2160)²

Non-Touch

Tilt: 5 degrees forward and 25 degrees back

HP EliteOne 1000 34-in WQHD Curved Display¹

34" diagonal IPS widescreen WLED backlit anti-glare WQHD LCD (3440 x 1440) 2

Non-Touch Tilt: 0 degrees forward and 20 degrees back

- 1. HD and 4K content required to view HD and 4K images.
- 2. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

NOTE: Display options are configured at purchase with the HP EliteOne 1000 G1 AiOs.

NOTE: Separately purchased, interchangeable displays in sizes 23.8" (60.45 cm), 27" (68.58 cm) and 34" (86.36 cm) diagonal are planned to be available after launch in November 2017.



Features

STORAGE AND DRIVES¹

2.5 inch 7.2k RPM Hard Disk Drives

500GB SATA 1TB SATA

2.5 inch Solid State Hybrid Drives (SSHD)

500GB 5400RPM 2.5in 8GB Hybrid 1TB 5400RPM 2.5in 8GB Hybrid 2TB 5400RPM 2.5in 8GB Hybrid

2.5 inch 5.4k RPM Hard Disk Drives

2TB SATA

2.5 inch Self-encrypting Drives (SED HDD)

500GB 7200RPM 2.5in SED OPAL 2

500GB 5400RPM 2.5in Federal Information Processing Standard (FIPS) SED

2.5 SATA SSD Drives

128GB SATA TLC SSD 256GB SATA TLC SSD 512GB SATA TLC SSD

2.5 inch Self-encrypting Drives (SED SSD)

256GB TLC SED SSD OPAL 2 Drive 512GB TLC SED SSD OPAL 2 Drive 256GB TLC SED SSD 2.5in Federal Information Processing Standard (FIPS) SED 512GB TLC SED SSD 2.5in Federal Information Processing Standard (FIPS) SED

PCIe NMVe SSD Drives

256GB PCIe NVMe TLC SSD 512GB PCIe NVMe TLC SSD 1TB PCIe NVMe TLC SSD 256GB PCIe NVMe SSD 512GB PCIe NVMe SSD

1. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.



Features

MEMORY¹

Maximum

32GB (16GB/slot)

Memory Slots

2 SODIMM DDR4-2400 (Transfer rates up to 2400 MT/s) Double channel support Customer accessible/upgradeable

Configurations

4 GB (4096 MB x 1) Intel® Optane Memory 16GB SSD (cache)

1. Intel® Optane™ for HP desktops and notebooks is sold separately and requires a 7th Gen Intel® Core™ processor, bios version with Intel® Optane™ supported, Windows 10, version 1703, an Intel® 200 series chipset, M.2 type 2280–S1-B-M connector on a PCH Remapped PCIe Controller and Lanes in a x2 or x4 configuration with B-M keys that meet NVMe Spec 1.1 and Intel® Rapid Storage Technology (Intel® RST) 15.5 driver

NETWORKING/COMMUNICATIONS

Wireless LAN^{1,2,3}

Intel® 8265 802.11AC 2x2 Wi-Fi +Bluetooth® M.2 Combo Card vPro™ (802.11AC Wave 2 supported)
Intel® 8265 802.11AC 2x2 Wi-Fi +Bluetooth® M.2 Combo Card non-vPro™ (802.11AC Wave 2 supported)
Intel® 7265 802.11AC 2x2 Wi-Fi +Bluetooth® M.2 Combo Card non-vPro™
Realtek RTL8822BE ac 2x2 Wi-Fi +Bluetooth® M.2 Combo Card

Ethernet (RJ-45) Integrated

Intel® I219LM Gigabit Network Connection LOM (standard)

- 1. Wireless LAN is optional and must be bought at purchase
- 2. Wireless access point and Internet service required and not included. Availability of public wireless access points limited.
- The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.

AUDIO/MULTIMEDIA

Audio

Integrated Conexant CX5001 codec - up to 24-bit PCM High performance integrated stereo speakers (2W) Headset side port (3.5mm) Headphone rear port (3.5mm) Multi-streaming capable¹

 The side headset connector supports CTIA style headsets and is re-taskable as a Line-in, Microphone-in or Headphone-out port. Rear audio input ports are re-taskable as a Line-in or Microphone-in port. External speakers must be powered externally. Multi-streaming can be enabled in the audio control panel to allow independent audio streams to be sent to/from the front and rear jacks or internal speakers. This allows for different audio applications to use separate audio ports on the system. For example, the front jacks could be used with a headset for a communications application while the rear jacks are being used with external speakers and a multimedia application.



Features

High Definition Integrated
Audio Conexant CX5001

Universal Audio Jack with CTIA headset support (re-taskable for headphone/line out/microphone in/line in)

Uses OS soft wavetable

Two speakers

44.1kHz/48kHz/96kHz/192kHz

44.1kHz/48kHz/96kHz

Webcams & Mic Pop-up Webcam 2MP FHD webcam, Up to 30 frames/sec, discrete dual

array microphone (Fixed 2MP FHD 1080p)(maximum

resolution of 1920 x1080)

IR and Dual-facing Pop-up Web Camera 2MP FHD webcam with IR camera front-facing and 2nd

rear-facing 2MP webcam, Up to 30 frames/sec, discrete dual array microphone (Dual Camera 480P IR+1080P

RGB Fixed/2MP FHD 1080P Fixed)

Supporting Windows10 Hello

Collaboration

Integrated, capacitive touch collaboration keys functions include:

Keys Call answer

Microphone mute Webcam mute Hang up

Speaker mute, and volume slider



Features

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard and Mouse Combos

HP Premium Wireless Keyboard and Mouse HP Premium USB Wired Keyboard and Mouse HP USB Keyboard and Mouse Healthcare Edition HP Wireless Business Slim Keyboard and Mouse

Keyboards

HP Premium USB Wired Keyboard
HP USB Business Slim Keyboard
HP USB Business Slim Grey Keyboard
HP USB Business Slim CCID SmartCard Keyboard
HP USB Business Slim Antimicrobial Keyboard (China Only)
HP USB Wired Keyboard
HP Wired Keyboard EPEAT®

Mice

HP USB 1000dpi Laser Mouse HP Grey V2 Mouse HP USB Mouse HP USB Antimicrobial Mouse¹ HP USB Hardened Mouse HP USB PS/2 Wired Washable Mouse

Other

HP Mouse Pad

Adapters and Cables

DisplayPort™ 1.2 Cable
DisplayPort™ 1.2 to DVI-D Adapter
DisplayPort™ 1.2 to HDMI 4K Adapter
DisplayPort™ 1.2 to VGA Adapter
HP DVI Cable
HP Type-C to Type-A Hub
HP USB to Serial Port Adapter
HP USB-C to USB 3.0 Adapter

Headsets

HP Business Headset v2 HP UC Bluetooth® Headset

1. China Only



Technical Specifications

SOFTWARE AND SECURITY

HP BIOS

HP BIOSphere Gen31

HP Sure Start Gen31

HP BIOS Protection (BIOS Update via Network, Master Boot Record Security, Pre-Boot Security, Secure Erase, Hybrid Boot, Measured Boot, Secure Boot, Absolute Persistence Module, Pre-boot Authentication)

Software

HP Native Miracast Support²

HP LAN-Wireless Protection

HP SureConnect

HP Velocity

HP ePrint + JetAdvantage³

HP Hotkey Support - CMIT

HP Recovery Manager

HP Jumpstart

HP Support Assistant⁴

HP Noise Cancellation Software

HP PhoneWise

Buy Office

Bing Search

Intel Unite

Manageability Features

HP Driver Packs

HP System Software Manager

HP BIOS Config Utility (BCU)

HP Client Catalog

HP Management Integration Kit for Microsoft System Center Configuration Manager⁵

LANDESK Management⁶

Client Security Software

HP Client Security Suite Gen 3 [HP Security Manager (HP Credential Manager, HP Password Manager, HP Spare Key), HP Power On Authentication, HP Device Access Manager]⁷

Trusted Platform Module TPM 2.0 Embedded Security Chip (SLB9670 -Common Criteria EAL4 + Certified)

SATA 0,1 port disablement (viaBIOS)

DriveLock

Serial or USB enable/disable (viaBIOS)

Power-on password (viaBIOS)

Setup password (viaBIOS)

Support for chassis padlocks and cable lock devices

Integrated hood sensor

Microsoft Defender⁸

HP Fingerprint Reader



Technical Specifications

- 1. HP BIOSphere Gen3: Requires Intel® 7th generation processors
- 2. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information:
 - http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast
- 3. Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see www.hp.com/go/eprintcenter). Print times and connection speeds may vary
- 4. Requires Windows and Internet Access
- 5. HP Management Integration Kit for Microsoft System Center Configuration Manager: HP Management Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html
- 6. Subscription required
- 7. Requires Windows and Intel® 7th generation processors
- 8. Opt in and internet connection required for updates.

POWER

Power Supply

External

External 180W

Power Cord

Power cord length: 6.0 ft. (1.83 m)



Technical Specifications

WEIGHTS & DIMENSIONS

Weight

23.8 Non Touch Product Weight (Unboxed) Without Arm

4.17 kg, 10.3 lb

Without Base 5.19 kg, 11.3 lb

Whole system with Base

8.21 kg, 18.1 lb

23.8 Touch Product Weight (Unboxed) Without Arm

4.17 kg, 10.3 lb

Without Base 5.26 kg, 11.6 lb

Whole system with Base

8.28 kg, 18.25 lb

23.8 Shipping Weight (Boxed) System with package weight

12.42 kg, 27.38 lb

23.8 Shipping Weight (Pallet)

Total Weight including pallet

247 kg, 544.54 lb

Dimension

23.8 System Dimensions (including Touch, Non Touch) Without Base

21.2 x 1.3 x 12.8 in (539.5 x 33 x 324.9 mm)

Base only

15.7 x 7.5 x 1.5 in (400 x 190 x 37 mm)

With Base

21.2 x 7.5 x 16.5 in (539.5 x 190 x 419.2 mm)

23.8 Shipping Dimensions (Boxed) Package

25.87 x 9.76 x 20.9 in (657 x 248 x 531 mm)

23.8 Shipping Dimensions (Pallet)

Shipping pallet size

45.39 x 35.63 x 68.03 in (1153 x 905 x 1728 mm)

23.8 Pallet Quantity (including Touch, Non-Touch) 18 units per pallet

Weight

27 Product Weight (Unboxed) Without Arm

6.75 kg, 14.9 lb

Without Base



Technical Specifications

7.25 kg, 16.0 lb

Whole system with Base

10.2 kg, 22.5 lb

27 Shipping Weight (Boxed)

System with package weight

14.62 kg, 32.23 lb (maximum config.)

27 Shipping Weight (Pallet) Total Weight including pallet

243 kg, 535.72 lb

Dimension

27 System Dimensions Without Base

24.15 x 1.19 x 14.44 in (613.3 x 30.5 x 366.7 mm)

Base only

15.7 x 7.5 x 1.5 in (400 x 190 x 37 mm)

With Base

24.15 x 7.5 x 18 in (613.3 x 190 x 457.3 mm)

27 Shipping Dimensions (Boxed) Package

29.71 x 9.57 x 22.52 in (741 x 243 x 572 mm)

27 Shipping Dimensions (Pallet) Shipping pallet size

43.39 x 38.74 x 62.87 in (1102 x 984 x 1851 mm)

27 Pallet Quantity 15 units per pallet

Weight

34 Product Weight (Unboxed) Without Arm

6.8 kg, 15.0 lb

Without Base

7.28 kg, 16 lb

Whole system with Base

10.3 kg, 22.8 lb

34 Shipping Weight (Boxed) System with package weight

17.32 kg, 38.14 lb

34 Shipping Weight (Pallet)

Total Weight including pallet

228 kg, 502.65 lb

Dimension

34 system Dimensions Without Base

32.1 x 2.9 x 14.44 in (815.8 x 73.8 x 366.7 mm)



Technical Specifications

Base only

15.7 x 7.5 x 1.5 in (400 x 190 x 37 mm)

With Base

32.1 x 7.5 x 18 in (815.8 x 190 x 457.3 mm)

34 Shipping Dimensions (Boxed) Package

38.78 x 11.5 x 23.94 in (985 x 292 x 608 mm)

34 Shipping Dimensions (Pallet) Shipping pallet size

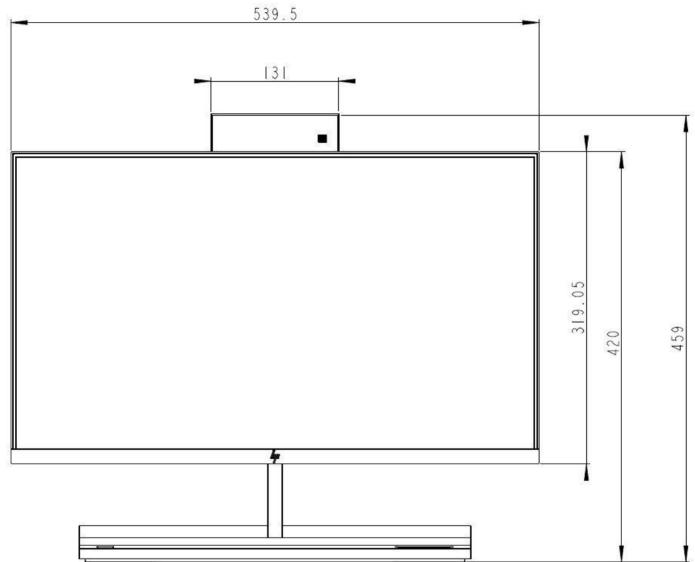
45.98 x 38.74 x 77.13 in (1168 x 984 x 1959 mm)

34 Pallet Quantity 12 units per pallet



Technical Specifications

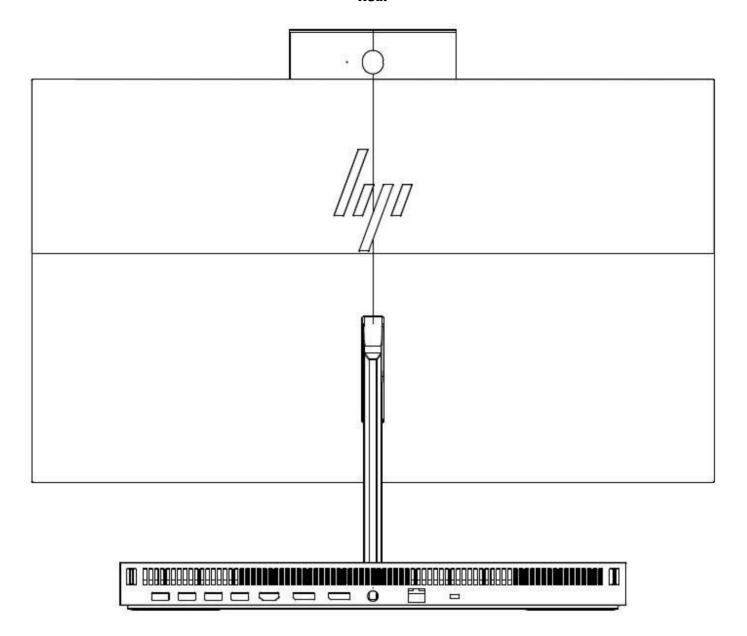
HP EliteOne 1000 G1 23.8-in AiO (Touch and NonTouch) Dimensions Front





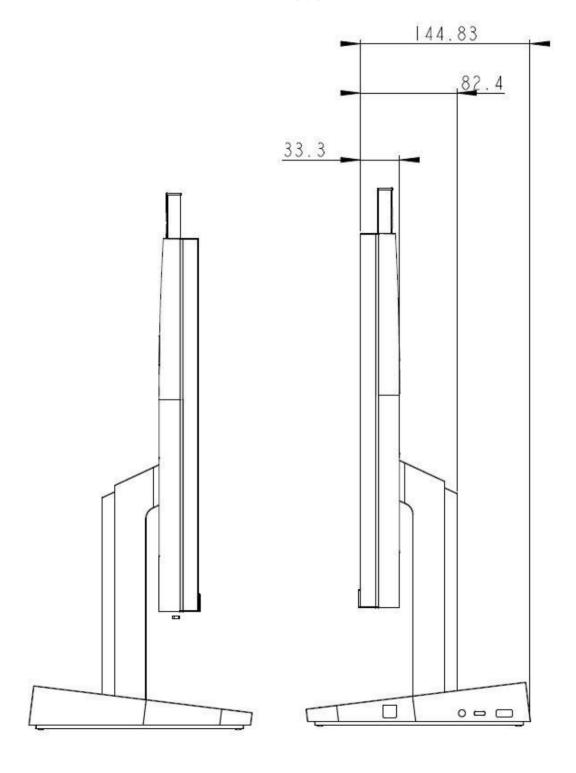
Technical Specifications

HP EliteOne 1000 G1 23.8-in AiO (Touch and NonTouch) Dimensions Rear



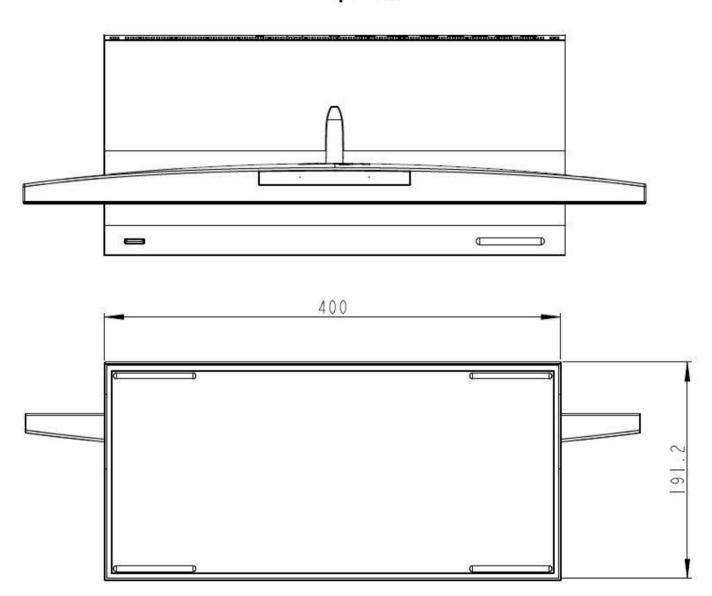


HP EliteOne 1000 G1 23.8-in AiO (Touch and NonTouch) Dimensions Side





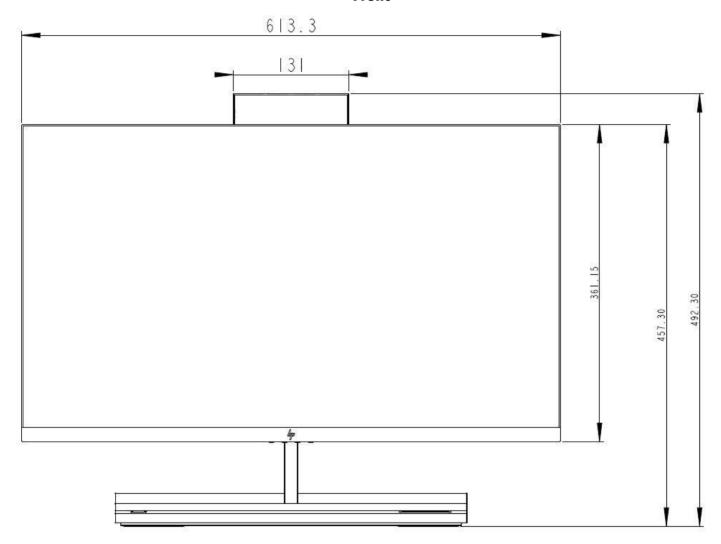
HP EliteOne 1000 G1 23.8-in AiO (Touch and NonTouch) Dimensions Top & Bottom





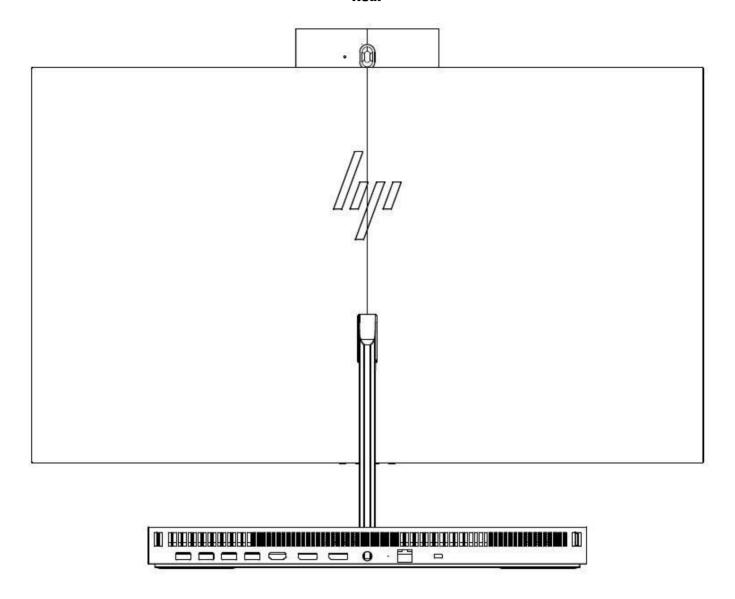
Technical Specifications

HP EliteOne 1000 G1 27-in 4K UHD AiO Dimensions Front



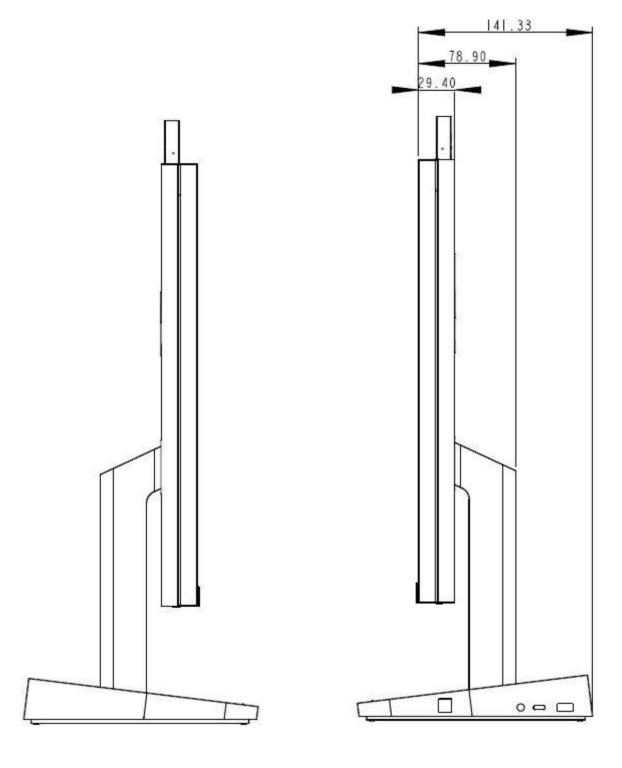


HP EliteOne 1000 G1 27-in 4K UHD AiO Dimensions Rear

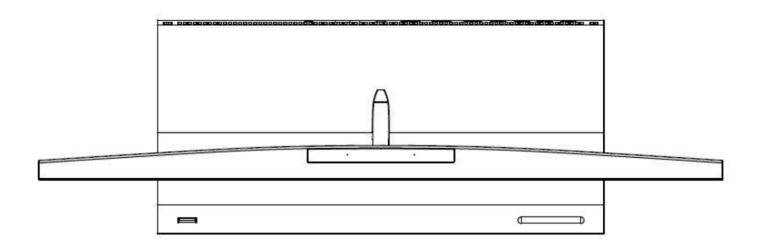


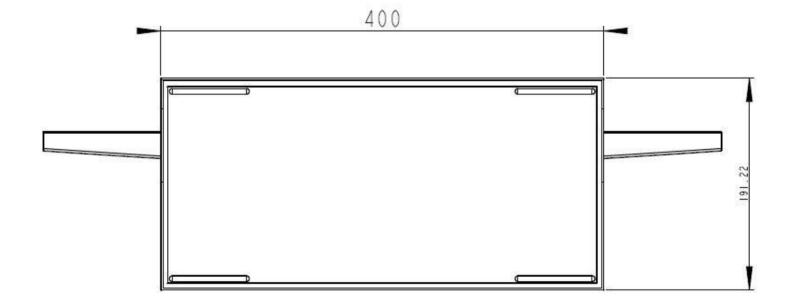


HP EliteOne 1000 G1 27-in 4K UHD AiO Dimensions Side



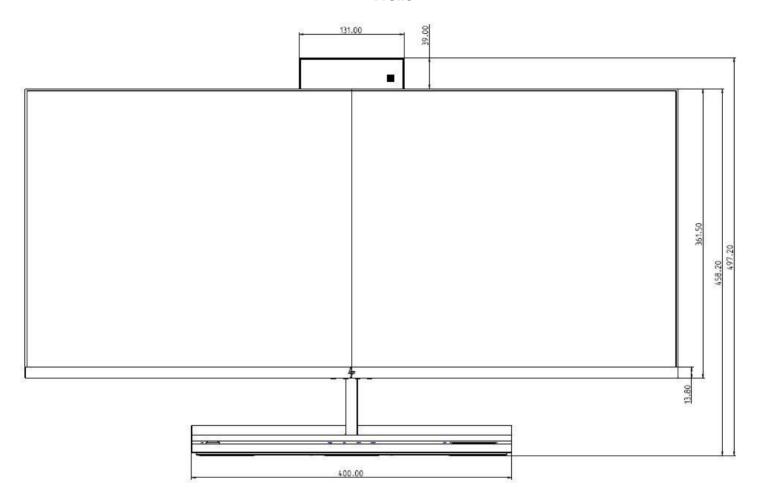
HP EliteOne 1000 G1 27-in 4K UHD AiO Dimensions Top & Bottom





Technical Specifications

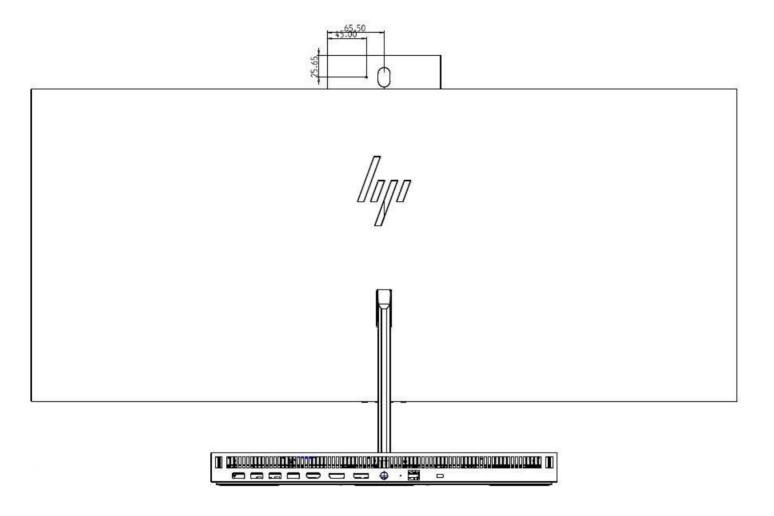
HP EliteOne 1000 G1 34-in Curved AiO Dimensions Front





Technical Specifications

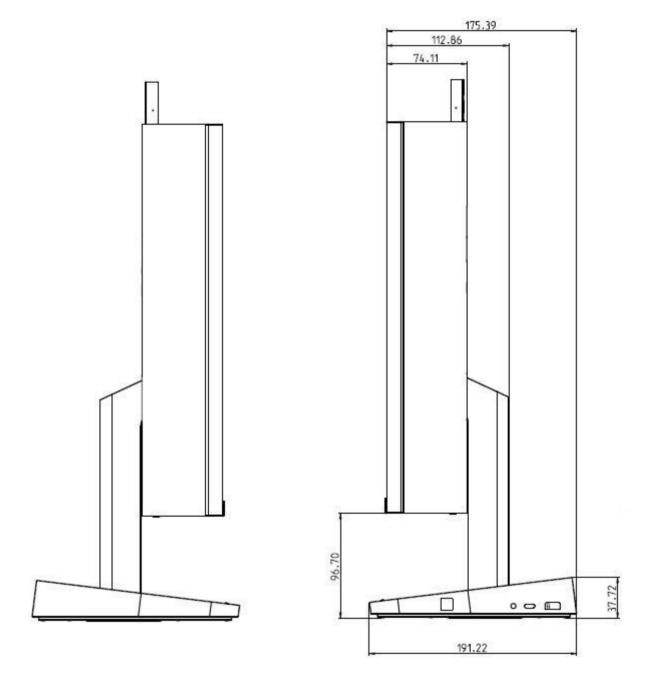
HP EliteOne 1000 G1 34-in Curved AiO Dimensions Rear





Technical Specifications

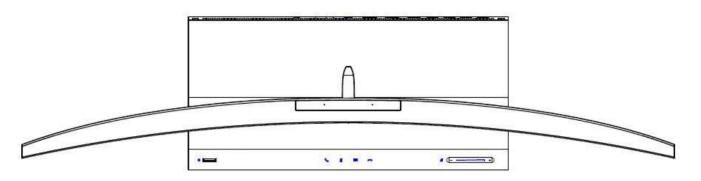
HP EliteOne 1000 G1 34-in Curved AiO Dimensions Side

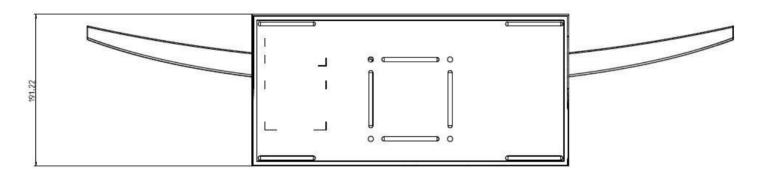




Technical Specifications

HP EliteOne 1000 G1 34-in Curved AiO Dimensions Top & Bottom







Technical Specifications

ENVIRONMENTAL & INDUSTRY

HP EliteOne 1000 G1 23.8-in Touch All-in-One Business PC

Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT®: Gold registered in the United States. See http://www.epeat.net for registration status in your country. Search keyword *generator* on HP's 3rd party option store for solar energy accessory at http://www.hp.com/go/options.
- TCO Certified Edge

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the All-in-One PC model is based on a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Energy Consumption (in accordance with US ENERGY STAR® test method)

Normal Operation (Short	
idle)	
Normal Operation (Long	
idle)	
Sleep	
Off	

115VAC, 60Hz 21.38 W	230VAC, 50Hz 21.68 W	100VAC, 50Hz 21.15 W
8.53 W	8.78 W	8.80 W
4.35 W	4.30 W	4.39 W
0.82 W	0.87 W	0.82 W

Note: Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*
Normal Operation (Short
idle)
Normal Operation (Long
idle)
Sleep
Off

115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
73 BTU/hr	74 BTU/hr	72 BTU/hr
29 BTU/hr	30 BTU/hr	30 BTU/hr
15 BTU/hr	15 BTU/hr	15 BTU/hr
3 BTU/hr	3 BTU/hr	3 BTU/hr

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise
Emissions
(in accordance with
ISO 7779 and ISO 9296)
Typically Configured –
Idle
Fixed Disk – Random
writes

Longevity and Upgrading

Sound Power (Lwad, bels)	Sound Pressure (L _{PAm} , decibels)	
(LWAG, DCt3)	уграні, иссівсіз/	
2.0	15	

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

14

- 6 USB ports
- 2 memory slots
- 1 Mini PCIe half-length slot

2.9



Technical Specifications

- 1 MXM 3.0 Type A 35W slot
- 1 mSATA slot
- 1 2.5" internal bay supporting up to Two 2.5" hard drives (HDD/SSD/SED/SSHD)
- 15.25" external supporting optical drive

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive
 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see http://www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 38.3% post-consumer recycled plastic (by wt.)
- This product is 95.8% recycle-able when properly disposed of at end of life.

Packaging Materials

External:PAPER/Corrugated1415 gInternal:PLASTIC/EPS (Expanded Polyethylene)647 gPLASTIC/Polyethylene low density60 g

The plastic packaging material contains at least 100% recycled content.

The corrugated paper packaging materials contains at least 80% recycled content.

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)



Technical Specifications

- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

HP, Inc. Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:

http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842

and

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf



Technical Specifications

HP EliteOne 1000 G1 23.8-in All-in-One Business PC

Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT®: Gold registered in the United States. See http://www.epeat.net for registration status in your country. Search keyword *generator* on HP's 3rd party option store for solar energy accessory at http://www.hp.com/go/options.
- TCO Certified Edge

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the All-in-One PC model is based on a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Energy Consumption (in accordance with US ENERGY STAR® test

method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	21.38 W	21.68 W	21.15 W
Normal Operation (Long idle)	8.53 W	8.78 W	8.80 W
Sleep	4.35 W	4.30 W	4.39 W
Off	0.82 W	0.87 W	0.82 W

Note: Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation* Normal Operation (Short	115VAC, 60Hz 73 BTU/hr	230VAC, 50Hz 74 BTU/hr	100VAC, 50Hz 72 BTU/hr
idle) Normal Operation (Long idle)	29 BTU/hr	30 BTU/hr	30 BTU/hr
Sleep	15 BTU/hr	15 BTU/hr	15 BTU/hr
Off	3 BTU/hr	3 BTU/hr	3 BTU/hr

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with	Sound Power (L _{WAd} , bels)	Sound Pressure (L _{PAm} , decibels)
ISO 7779 and ISO 9296) Typically Configured – Idle	2.9	15
Fixed Disk – Random writes	2.9	14

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 6 USB ports
- · 2 memory slots
- 1 Mini PCIe half-length slot
- 1 MXM 3.0 Type A 35W slot
- 1 mSATA slot



Technical Specifications

- 1 2.5" internal bay supporting up to Two 2.5" hard drives (HDD/SSD/SED/SSHD)
- 1 5.25" external supporting optical drive

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see http://www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and IS01043.
- This product contains 38.3% post-consumer recycled plastic (by wt.)
- This product is 95.8% recycle-able when properly disposed of at end of life.

Packaging Materials

External: PAPER/Corrugated 1415 q Internal: PLASTIC/EPS (Expanded Polyethylene) 647 q PLASTIC/Polyethylene low density 60 q

The plastic packaging material contains at least 100% recycled content.

The corrugated paper packaging materials contains at least 80% recycled content.

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- **Chlorinated Hydrocarbons**
- **Chlorinated Paraffins**
- Formaldehvde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- **Mercuric Oxide Batteries**
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)



Technical Specifications

- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these quidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

HP, Inc. Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:

http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842

and

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf



Technical Specifications

HP EliteOne 1000 G1 27-in 4K UHD All-in-One Business PC

Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT®: Gold registered in the United States. See http://www.epeat.net for registration status in your country. Search keyword *generator* on HP's 3rd party option store for solar energy accessory at http://www.hp.com/go/options.
- TCO Certified Edge

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the All-in-One PC model is based on a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Energy Consumption (in accordance with US ENERGY STAR® test

method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	34.04 W	34.24 W	33.94 W
Normal Operation (Long idle)	5.58 W	5.74 W	5.70 W
Sleep	1.34 W	1.38 W	1.35 W
Off	0.82 W	0.85 W	0.81 W

Note: Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short	116 BTU/hr	117 BTU/hr	116 BTU/hr
idle)			
Normal Operation (Long	19 BTU/hr	20 BTU/hr	19 BTU/hr
idle)			
Sleep	5 BTU/hr	5 BTU/hr	5 BTU/hr
Off	3 BTU/hr	3 BTU/hr	3 BTU/hr

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L _{WAd} , bels)	Sound Pressure (L _{pAm} , decibels)
Typically Configured – Idle	2.9	14
Fixed Disk – Random writes	2.9	15

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 6 USB ports
- · 2 memory slots
- 1 Mini PCIe half-length slot
- 1 MXM 3.0 Type A 35W slot
- 1 mSATA slot



Technical Specifications

- 1 2.5" internal bay supporting up to Two 2.5" hard drives (HDD/SSD/SED/SSHD)
- 15.25" external supporting optical drive

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive
 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see http://www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 36.1% post-consumer recycled plastic (by wt.)
- This product is 96.3% recycle-able when properly disposed of at end of life.

Packaging Materials

External:PAPER/Corrugated2072 gInternal:PLASTIC/EPS (Expanded Polyethylene)756 gPLASTIC/Polyethylene low density70 g

The plastic packaging material contains at least 100% recycled content.

The corrugated paper packaging materials contains at least 80% recycled content.

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)



Technical Specifications

- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these quidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

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Eco-label certifications

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:

http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842

and

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf



Technical Specifications

PORTS/SLOTS

Rear I/O Ports

Type A USB 3.1 Gen1 (Keyboard wake capable)

Type A USB 3.1 Gen1 DisplayPort™ 1.2 (out)

DisplayPort™ 1.2 (in)

UDMID OF (a...t)

HDMI 2.0a (out)

RJ45 network interface

Side I/O Ports

Type C USB 3.1 Gen1 (15W)

Type A USB 3.1 Gen1 (fast charging port)

Headset side port (3.5mm)

Expansion Slots

M.2 2230 for WLAN

M.2 2280 for NVMe SSD storage

Bays

2.5" HDD

CERTIFICATION AND COMPLIANCE

ENERGY STAR® certified EPEAT® Gold¹

1. EPEAT® registered where applicable. EPEAT registration varies by country. See http://www.epeat.net for registration status by country.

DISPLAYS

23.8" diagonal IPS widescreen WLED Touch backlit anti-glare LCD (1920 x 1080) Type IPS WLED Backlit LCD
Active area (mm) 527.04 x 296.46
Native Resolution (HxV) 1920 x 1080

Aspect ratio 16:09

Pixel pitch (HxV)(mm) 0.2745 x 0.2745
Contrast ratio (typical) 1000:01:00
Brightness (typical) 250 nits¹
Viewing angle (typical) (HxV) 178° x 178°

Backlight lamp life (to half 30,000 hours minimum

brightness)

Color support Over 16 million colors

Color gamut (typical) NTSC 72% Anti-glare Yes

Default color temperature Warm (6500K)



Technical Specifications

23.8" diagonal IPS widescreen WLED Nontouch backlit anti-glare LCD (1920 x 1080)

Type IPS WLED Backlit LCD Non-touch Display Active area (mm) 527.04 x 296.46

Native Resolution (HxV) 1920 x 1080 Aspect ratio 16:09

Pixel pitch (HxV)(mm) 0.2745 x 0.2745 Contrast ratio (typical) 1000:01:00 Brightness (typical) 250 nits1 Viewing angle (typical) (HxV) 178° x 178°

Backlight lamp life (to half 30,000 hours minimum

brightness)

Over 16 million colors Color support

Color gamut (typical) **NTSC 72%** Anti-glare Yes

Default color temperature Warm (6500K)

27" diagonal IPS widescreen WLED backlit anti-glare 4K UHD LCD (3840 x 2160)

IPS WLED Backlit LCD Type Active area (mm) 596.74 x 335.66 Native Resolution (HxV) 3840 x 2160 Aspect ratio 16:09

Pixel pitch (HxV)(mm) 0.1554 x 0.1554 Contrast ratio (typical) 1000:01:00 **Brightness** (typical) 350 nits1 Viewing angle (typical) (HxV) 178° x 178°

Backlight lamp life (to half

brightness)

Color support Over 1 billion colors

30,000 hours minimum

Color gamut (typical) sRGB 99% Anti-glare Yes

Default color temperature Warm (6500K)

34" diagonal IPS widescreen WLED backlit anti-glare WQHD LCD (3440 x 1440)

Type IPS WLED Backlit LCD Active area (mm) 799.80 x 334.8 Native Resolution (HxV) 3440 x 1440

Aspect ratio Pixel pitch (HxV)(mm) 0.2325 x 0.2325 Contrast ratio (typical) 1000:01:00

Brightness (typical) 300 nits1 Viewing angle (typical) (HxV) 178° x 178°

Backlight lamp life (to half 30,000 hours minimum

brightness)

Over 1 billion colors Color support



21:09

HP EliteOne 1000 G1 All-in-One Business PC

QuickSpecs

Technical Specifications

Color gamut (typical) sRGB 99%

Anti-glare Yes

Default color temperature Warm (6500K)

1. All performance specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.



Technical Specifications

STORAGE AND DRIVES

500 GB 7200 RPM SATA Hard Drive Capacity 500GB

Rotational Speed 7,200 RPM

Interface SATA 6 Gb/s

Buffer Size 16 MB

Logical Blocks 976,773,168

Seek Time 12 ms (Average)

Height 0.267 in/6.8 mm (nominal)
Width 2.75 in/70 mm (nominal)
Operating Temperature 41° to 131° F (5° to 55° C)

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

1TB

1 TB 7200 RPM SATA Hard

Capacity

Drive

Rotational Speed 7,200 RPM
Interface SATA 6 Gb/s
Buffer Size 32 MB

Logical Blocks 1,953,525,168 Seek Time 12 ms (Average)

Height 0.374 in/9.5 mm (nominal)
Width 2.75 in/70 mm (nominal)
Operating Temperature 41° to 131° F (5° to 55° C)

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

500 GB 5400 RPM Solid State Hybrid Drive Capacity 500GB Rotational Speed 5,400 RPM

Drive Type Solid State Hybrid Drive (SSHD) technology with NAND Flash

Interface SATA 6 Gb/s
Buffer Size 64 MB
NAND Flash 8GB

Seek Time 12 ms (Average)

Height0.267 in/6.8 mm (nominal)Width2.75 in/70 mm (nominal)Operating Temperature41° to 131° F (5° to 55° C)

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

1 TB 5400 RPM Solid State Hybrid Drive Capacity 1TB

Rotational Speed 5.400 RPM

Drive Type Solid State Hybrid Drive (SSHD) technology with NAND Flash

Interface SATA 6 Gb/s
Buffer Size 64 MB
NAND Flash 8GB



Technical Specifications

Seek Time 12 ms (Average)

Height 0.374 in/9.5 mm (nominal)
Width 2.75 in/70 mm (nominal)
Operating Temperature 41° to 131° F (5° to 55° C)

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

2TB

5.400 RPM

2 TB 5400 RPM Solid State Hybrid Drive Capacity

Rotational Speed

Drive Type

Solid State Hybrid Drive (SSHD) technology with NAND Flash

Interface SATA 6 Gb/s
Buffer Size 128 MB
NAND Flash 8GB

Seek Time 12 ms (Average)

Height 0.374 in/9.5 mm (nominal)
Width 2.75 in/70 mm (nominal)
Operating Temperature 41° to 131° F (5° to 55° C)

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

2 TB 5400 RPM SATA Hard Drive Capacity 2TB

Rotational Speed 5,400 RPM
Interface SATA 6 Gb/s
Buffer Size 128MB

Logical Blocks 3,907,050,336 Seek Time 12 ms (Average)

Height 0.374 in/9.5 mm (nominal)
Width 2.75 in/70 mm (nominal)
Operating Temperature 41° to 131° F (5° to 55° C)

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

500 GB SED Solid State

Drive

Capacity 500GB

Architecture Self-Encrypting (SED) Solid State Drive with SATA interface

Interface SATA 6 Gb/s
Buffer Size 16 MB
Logical Blocks 976,773,168

Seek Time12 ms (Average)Height0.267 in/6.8 mm (nominal)Width2.75 in/70 mm (nominal)

Operating Temperature 41° to 131° F (5° to 55° C)

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

Drive Weight Up to 50q (0.11lb)



Technical Specifications

Capacity 128GB

 Height
 7mm (0.276in)

 Width
 70mm (2.756 in)

 Interface
 SATA 3.0 (6Gb/s)

Performance

Maximum Sequential Read Up to 530MB/s
Maximum Sequential Write Up to 450MB/s
Logical Blocks 250,069,680

128 GB SATA TLC Solid

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

State Drive Features DIPM; TRIM;

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

256 GB SATA TLC Solid State Drive

Drive Weight Up to 50g (0.11lb)

Capacity 256GB

 Height
 7mm (0.276in)

 Width
 70mm (2.756 in)

 Interface
 SATA 3.0 (6Gb/s)

Performance

Maximum Sequential Read Up to 540MB/s
Maximum Sequential Write Up to 500MB/s
Logical Blocks 500,118,192

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features DIPM; TRIM;



Technical Specifications

512 GB SATA TLC Solid State Drive Drive Weight Up to 50g (0.11lb)

Capacity 512GB

 Height
 7mm (0.276in)

 Width
 70mm (2.756 in)

 Interface
 SATA 3.0 (6Gb/s)

Performance

Maximum Sequential Read Up to 540MB/s
Maximum Sequential Write Up to 500MB/s
Logical Blocks 1,000,215,216

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features DIPM; TRIM;

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

256 GB SATA TLC SED OPAL2 Drive Weight Up to 50g (0.11lb)

Solid State Drive

Capacity 256GB

 Height
 7mm (0.276in)

 Width
 70mm (2.756 in)

 Interface
 SATA 3.0 (6Gb/s)

Performance

Maximum Sequential Read Up to 540MB/s
Maximum Sequential Write Up to 500MB/s
Logical Blocks 500,118,192

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features DIPM; TRIM; Self Encrypting Drive with OPAL2.0

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

512 GB SATA TLC SED OPAL2 Drive Weight Up to 50g (0.11lb)

Solid State Drive

Capacity 512GB

 Height
 7mm (0.276in)

 Width
 70mm (2.756 in)

 Interface
 SATA 3.0 (6Gb/s)

Performance

Maximum Sequential Read Up to 540MB/s
Maximum Sequential Write Up to 500MB/s
Logical Blocks 1,000,215,216

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features DIPM; TRIM; Self Encrypting Drive with OPAL2.0



Technical Specifications

256 GB SATA TLC FIPS 140-2 Drive Weight Up to 50g (0.11lb)

SED Solid State Drive

Capacity 256GB

 Height
 7mm (0.276in)

 Width
 70mm (2.756 in)

 Interface
 SATA 3.0 (6Gb/s)

Performance

Maximum Sequential Read Up to 540MB/s
Maximum Sequential Write Up to 500MB/s
Logical Blocks 500,118,192

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features DIPM; TRIM; FIPS 140-2

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

512GB 2.5" SATA-3 TLC FIPS Drive Weight Up to 50g (0.11lb)

140-2 SED Solid State Drive Capacity

Capacity 512GB

 Height
 7mm (0.276in)

 Width
 70mm (2.756 in)

 Length
 80mm (3.15in)

 Interface
 SATA 3.0 (6Gb/s)

Performance

Maximum Sequential Read Up to 540MB/s
Maximum Sequential Write Up to 500MB/s
Logical Blocks 1,000,215,216

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features DIPM; TRIM; FIPS 140-2

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

256GB M.2 PCIE NVME Solid Drive Weight Up to 10g (0.022lb)

State Drive

Capacity 256GB

 Height
 2.38mm (0.093in)

 Width
 22mm (0.87in)

 Length
 80mm (3.15in)

 Interface
 PCIE Gen3

Performance

Maximum Sequential Read Up to 1600MB/s
Maximum Sequential Write Up to 550MB/s
Logical Blocks 500,118,192

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features APST; ASPM L1.2; NVME spec 1.2



Technical Specifications

512GB M.2 PCIE NVME Solid Drive Weight Up to 10g (0.022lb)

State Drive Capacity 512GB

 Height
 2.38mm (0.093in)

 Width
 22mm (0.87in)

 Length
 80mm (3.15in)

 Interface
 PCIE Gen3

Performance

Maximum Sequential Read Up to 1800MB/s
Maximum Sequential Write Up to 550MB/s
Logical Blocks 1,000,215,216

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features APST; ASPM L1.2; NVME spec 1.2

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

256GB M.2 PCIE NVME TLC Drive Weight Solid State Drive

Drive Weight Up to 10g (0.022lb)

Capacity 256GB

 Height
 2.38mm (0.093in)

 Width
 22mm (0.87in)

 Length
 80mm (3.15in)

 Interface
 PCIE Gen3 x 4

Performance

Maximum Sequential Read Up to 2700MB/s
Maximum Sequential Write Up to 1100MB/s
Logical Blocks 500,118,192

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features APST; ASPM L1.2; NVME spec 1.2

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

512GB M.2 PCIE NVME TLC Solid State Drive

METLC Drive Weight Up to 10g (0.022lb)

Capacity 512GB

 Height
 2.38mm (0.093in)

 Width
 22mm (0.87in)

 Length
 80mm (3.15in)

 Interface
 PCIE Gen3 x 4

Performance

Maximum Sequential Read Up to 2700MB/s
Maximum Sequential Write Up to 1400MB/s
Logical Blocks 1,000,215,216

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features APST; ASPM L1.2; NVME spec 1.2



Technical Specifications

1TB M.2 PCIE NVME TLC Solid State Drive Drive Weight Up to 10g (0.022lb)

Capacity 1TB

 Height
 2.38mm (0.093in)

 Width
 22mm (0.87in)

 Length
 80mm (3.15in)

 Interface
 PCIE Gen3 x 4

Performance

Maximum Sequential Read Up to 2700MB/s
Maximum Sequential Write Up to 1500MB/s
Logical Blocks 2,000,409,264

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features APST; ASPM L1.2; NVME spec 1.2

NOTE: 1MB = 1,000,000 Bytes, 1GB = 1,000,000,000 Bytes



Technical Specifications

GRAPHICS

Intel® HD Graphics (integrated) **VGA Controller** Integrated

DisplayPort™ 1.2 Multimode capable; supports HDCP, DisplayPort™ 1.2 Audio (2 streams),

HBR2 link rates and Multi-Stream Technology for a maximum of 3 displays

(including the integrated panel and all attached displays)

HDMI Supports HDMI 2.0a features

Supports HDCP 2.2

Supports BT2020 and HDR playback (7th Gen processors only)

Memory Allocated at system startup and configurable using F10 setup with values of

128MB, 256MB, 512MB and 1024MB. Additional memory that is not in use by the host will be dynamically allocated and will vary depending on the

total installed system memory.

Maximum Color Depth

Graphics/Video API Support

32 bits/pixel, 8-bits per color component 6th Generation Intel® Core™ Processors With Intel® Graphics 580, 550, 540 With Intel® HD Graphics 530, 520, 515

7th Generation Intel® Core™ Processors
With Intel® HD Graphics 620, 615

DirectX 12, OpenGL 4.4, OpenCL 2.0, Intel® Quick Sync Video

7th Generation Intel® Core™ Processors With Intel® HD Graphics 505, 500

DirectX 12, OpenGL 4.4, OpenCL 2.0, Intel· Quick Sync Video

Subtitle Video Inputs

Key Features 1 Standard size DP input connector

Monitor function is available whenever power is connected to the system,

and the On Screen Display is configured to use the port

Supports HDCP.

DisplayPort™ 1.2 audio is not supported.

34" UHD Supported Resolutions and Refresh Rates. Other resolutions may also work.

640x480 60 Hz 640x480 67Hz 640x480 72Hz 640x480 75Hz 720x400 70Hz

800x600 60Hz 800x600 75Hz 1024x768 60Hz 1024x768 75Hz 1280x960 60Hz 1280x720 60Hz 1280x1024 60Hz 1280x1024 75Hz 1440x900 60Hz 1440x900 75Hz 1680x1050 60Hz 1920x1080 60Hz

3440x1440 60Hz (Native Resolution)

3440x1440 30Hz

27" UHD Supported Resolutions. Other resolutions may also work. 640x480 60Hz 640x480 67Hz 640x480 72Hz 640x480 75Hz

720x400 70Hz



Technical Specifications

800x600 56Hz 800x600 60Hz 800x600 72Hz 800x600 75Hz 832x624 75Hz 1024x768 60Hz 1024x768 70Hz 1024x768 75Hz 1280x720 60Hz 1280x960 60Hz 1280x1024 60Hz 1280x1024 75Hz 1440x900 60Hz 1680x1050 60Hz 1920x1080 60Hz

3840x2160 60Hz (Native Resolution)

3840x2160 30Hz

 23.8 FHD Supported
 640x480 60Hz

 Resolutions and Refresh
 720x400 70Hz

 Rates. Other resolutions
 800x600 60Hz

 may also work.
 1024x768 60Hz

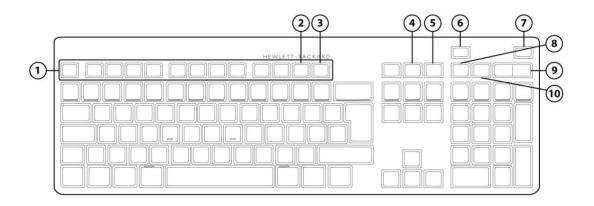
640x480 60Hz 720x400 70Hz 800x600 60Hz 1024x768 60Hz 1280x720 60Hz 1280x800 60Hz 1280x1024 60Hz 1440x900 60Hz 1600x900 60Hz 1680x1050 60Hz

1920x1080 60Hz (Native Resolution)



Technical Specifications

INPUT/OUTPUT DEVICES



HP Conferencing Keyboard

- 1. Function Keys
- 2. F11 Lync or Skype for Business Contact list¹
- 3. F12 Lync or Skype for Business Calendar²
- 4. Share Screen
- 5. Stop Webcam

- 6. End/Decline a Call
- 7. Answer a Call
- 8. Microphone Mute
- 9. Volume Up/Down
- 10. Audio Mute
- 1. Microsoft Lync 2013, or Skype for Business, or Microsoft Outlook 2013 Contact list
- 2. Microsoft Lync 2013, or Skype for Business, or Microsoft Outlook 2013 Calendar

Technical Specifications

HP USB Premium Keyboard

Keys 104, 105 layout (depending upon country)

Physical Characteristics Dimensions

(L x W x H) 17.04 x 5.55 x 0.52 in (433 x 141 x13.2 mm)

Weight 1.54 lb (698g)

Operating voltage 5 VDC, +/-5%

Power consumption 35mA (All LED on)

System interface USB Type A plug connector

ESD Contact Discharge: 8 KV Air Discharge: 15 KV

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC 99 - 2001 Functionally compliant

Switch actuation 60±10g nominal peak force with tactile feedback

Switch life 10 million keystrokes (Life tester)

Switch type Contamination-resistant switch membrane
Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Operating temperature 50° to 122° F (10° to 50° C) Non-operating temperature 4° to 149° F (-20° to 65° C)

Operating humidity 10% to 95% (non-condensing at ambient)
Non-operating humidity 0% to 95% (non-condensing at ambient)

Operating shock 40 g, six surfaces

Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration

Drop (out of box)

26 in (66 cm) on carpet, six-drop sequence

Drop (in box)

42 in (107 cm) on concrete, 16-drop sequence

4-g peak acceleration

Approvals UL, FCC, CE Mark, TUV GS, VCCI, BSMI, C-Tick, KC

Ergonomic compliance TUVGS

Non-operating vibration

Kit contents Keyboard, QSP Warranty Card Product Notice

Skylab USB Wired Keyboard

Environmental

Keys 104, 105, 106, 107, 109 layout (depending upon country)

Physical Characteristics Dimensions 171.97 x 68.35 x 8.27 in (436.8± 1.5 x 137.6± 1.0 x 21.0±

(L x W x H) 1.0 cm)

Weight 1.32 lb (0.6± 0.08 kg)



Technical Specifications

Operating voltage 4.4-5.25VDC

Power consumption 50-mA maximum (with 5 VDC power supplied and three

LEDs ON)

Electrical System interface USB

ESD Contact Discharge: 2, 4,6,8KV

Air Discharge: 2, 4, 8,10,12.5KV

EMI - RFI Conforms to FCC rules for a Class B computing device

Keycaps Low-profile design

Switch actuation 60±10g nominal peak force with tactile feedback

Switch life 10 million keystrokes (Life tester)

Switch type Contamination-resistant switch membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Acoustics 43-dBA maximum sound pressure level

Operating temperature 50° to 122° F (10° to 50° C)

Non-operating temperature Minus 30 degress to 60 degress Celsius

Operating humidity 10% to 90% (non-condensing at ambient)

Non-operating humidity 20% to 80% (non-condensing at ambient)

Operating shock 40 g, six surfaces

Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration

Non-operating vibration 4-g peak acceleration

Drop (out of box)

26 in (66 cm) on carpet, six-drop sequence

Drop (in box)

30 in (76.2 cm) on concrete, 16-drop sequence

Approvals

UL, FCC, CE Mark, TUV GS, VCCI, BSMI, C-Tick, KC

Ergonomic compliance ANSI HFS 100, ISO 9241-4, and TUVGS

Kit contents Keyboard, Installation Guide, Warranty card, Safety and

Comfort Guide

HP PS/2 Mouse

Environmental

Mechanical

Dimensions 4.21 x 2.64 x 1.52 in (107 x 67 x 38.7 mmm) (H x L x W)

Weight 0.19lb (90q)

Operating temperature 50° to 122°F (10° to 50° C)

Non-operating temperature -22° to 140°F (-30° to 60° C)

Environmental Operating humidity 10% to 90%

(non condensing at ambient)

Non-operating humidity 20% to 80%

(non condensing at ambient)



Technical Specifications

Operating shock 50 g, 6 surfaces Non-operating shock 80 g, 6 surfaces

Operating vibration 2 g peak acceleration
Non-operating vibration 4 g peak acceleration

Operating voltage 5 VDC ± 10%

Power consumption 100mA Connector USB 2.0

Type 3D mouse (3 keys and wheel)

Resolution 800, 1200, 1600 DPI
Sensor Pixart PAN3606DL
Tracking speed 30 inch/sec (max)

Tracking acceleration 8G(max), 1G=9.8m/s2

Cable length 6 ft (1.8 m)
Color Jack Black

Regulatory Approvals UL, FCC, CE Mark, TUV GS, VCCI, BSMI, C-Tick, KC

HP USB Mouse

Electrical

Mechanical

Dimensions 2.5 x 4.5 x 1.5 in (63.5 x 114.3 x 38.1 mm) (H x L x W)

Weight 0.19lb (90g)

Color Black
Connector USB

Resolution 799 DPI sensitivity

Buttons Two primary buttons and clickable scroll wheel

NETWORKING/COMMUNICATIONS

Intel® 1219LM Gigabit Network Connection LOM (standard) **Connector** RJ-45 **System Interface** PCIe + SMBus

Controller Intel® I219LM Gigabit Ethernet Controller

Data rates supported Supports operation at 10/100/1000 Mb/s data rates

IEEE Compliance

• IEEE 802.3 Ethernet interface for 1000BASE

• IEEE 802.3 Ethernet interface for 1000BASE-T, 100BASETX, and 10BASET applications (802.3ab, 802.3u, and 802.3i, respectively)

EEE 802.3az support [Low Power Idle (LPI) mode]
 IEEE 802.3u auto-negotiation conformance

• Jumbo Frames (up to 9 kB)

• 802.10 & 802.1p

Receive Side Scaling (RSS)

Two Queues (Tx & Rx)



Technical Specifications

Power

- Ultra Low Power at cable disconnect (<1 mW) enables platform support for connected standby
- Reduced power consumption during normal operation and power down modes
- Integrated Intel® Auto Connect Battery Saver (ACBS)
- Single-pin LAN Disable for easier BIOS implementation
- Fully integrated Switching Voltage Regulator (iSVR)
- Low Power Link-Up (LPLU)

MAC/PHY Interconnect

- PCIe-based interface for active state operation (S0 state)
- SMBus-based interface for host and management traffic (Sx low power state)

Management Interface MDC/MDIO management interface

Security & Manageability Intel® vPro™ support with appropriate Intel® chipset components



Technical Specifications

WLAN

Intel® 7265 802.11a/b/q/n/ac (2x2) Wi-Fi and Bluetooth® 4.2 Combo¹

Wireless LAN Standards

IEEE 802.11a IEEE 802.11b IEEE 802.11a IEEE 802.11n IEEE 802.11ac

Interoperability

Frequency Band

802.11b/q/n

• 2.402 – 2.482 GHz

802.11a/n

4.9 - 4.95 GHz (Japan)

5.15 - 5.25 GHz

5.25 - 5.35 GHz

5.47 - 5.725 GHz

5.825 - 5.850 GHz

Data Rates

802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

802.11ac: MCS0 ~ MCS9, (1SS and 2SS) (20MHz, 40MHz, and 80MHz)

Modulation

Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security¹

IEEE and Wi-Fi compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

IEEE 802.11i

Cisco Certified Extensions, all versions through CCX4 and CCX Lite

WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming Output Power² IEEE 802.11 compliant roaming between access points

802.11b: +14dBm minimum

802.11g: +12dBm minimum

802.11a: +12dBm minimum

802.11n HT20(2.4GHz): +12dBm minimum

802.11n HT40(2.4GHz): +12dBm minimum

802.11n HT20(5GHz): +10dBm minimum

802.11n HT40(5GHz): +10dBm minimum

802.11ac VHT80M(5GHz): +10dBm minimum

Power Consumption

Transmit: 2.0 W (max)

Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated) 50 mW (WLAN unassociated) Idle mode:



Technical Specifications

Connect Standby: 10 mW (WLAN+BT)

Radio disabled: 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230 : 2.3 x 22.0 x 30.0 mm

 Weight
 Type 2230 : 2.8g

 Operating Voltage
 3.3v +/- 9%

Temperature Operating 14° to 158° F (–10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED White – Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth Specification4.0/4.1/4.2 CompliantFrequency Band2402 to 2480 MHzNumber of AvailableLegacy : 0~79 (1 MHz/CH)ChannelsBLE : 0~39 (2 MHz/CH)

Data Rates andLegacy: 3 Mbps data rate; throughput up to 2.17 Mbps **Throughput**BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW



Technical Specifications

Electrical Interface

Bluetooth Software

Supported Link Topology Microsoft Windows Bluetooth Software

Power Management

Certifications

Microsoft Windows ACPI, and USB Bus Support FCC (47 CFR) Part 15C. Section 15.247 & 15.249

Power Management

ETS 300 328, ETS 300 826

USB 2.0 compliant

Certifications

Supported

Low Voltage Directive IEC950

Bluetooth Profiles

UL, CSA, and CE Mark

•

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 –Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

Intel® 8265 802.11a/b/g/n/ac (2x2) Wi-Fi and Bluetooth® 4.2

Combo¹

Wireless LAN Standards

IEEE 802.11a IEEE 802.11b

IEEE 802.11g IEEE 802.11n

IEEE 802.11ac

Interoperability

Frequency Band

802.11b/g/n

2.402 – 2.482 GHz

802.11a/n

4.9 – 4.95 GHz (Japan)

• 5.15 – 5.25 GHz

• 5.25 – 5.35 GHz

• 5.47 – 5.725 GHz

• 5.825 – 5.850 GHz

Data Rates

802.11b: 1, 2, 5.5, 11 Mbps

• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

• 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

802.11ac: MCS0 ~ MCS7, (1SS) (20MHz, 40MHz, and 80MHz)

Modulation Direct Sequence Spread Spectrum

Technical Specifications

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security³

 IEEE and Wi-Fi compliant 64 / 128 bit WEP encryption for a/b/g mode only

• AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x, WPA-PSK, WPA2-PSK, TKIP, and AES.

• WPA2 certification

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Roaming

Output Power²

IEEE 802.11 compliant roaming between access points

• 802.11b: +14dBm minimum

802.11g: +12dBm minimum

• 802.11a: +12dBm minimum

802.11n HT20(2.4GHz): +12dBm minimum

802.11n HT40(2.4GHz): +12dBm minimum

• 802.11n HT20(5GHz): +10dBm minimum

• 802.11n HT40(5GHz): +10dBm minimum

802.11ac VHT80(5GHz): +10dBm minimum

Power Consumption

Transmit: 2.0 W (max)
Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)
Idle mode: 50 mW (WLAN unassociated)
Connect Standby: 10 mW (WLAN+BT)

Radio disabled: 8 mW

Power Management

ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³

802.11b, 1Mbps: -93.5dBm maximum 802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

Antenna type

High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230 : 2.3 x 22.0 x 30.0 mm

 Weight
 Type 2230 : 2.8g

 Operating Voltage
 3.3v +/- 9%

Temperature

Operating 14° to 158° F (-10° to 70° C) Non-operating -40° to 176° F (-40° to 80° C)



Technical Specifications

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED White – Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2 Compliant **Frequency Band** 2402 to 2480 MHz

Number of Available Legacy : 0~79 (1 MHz/CH)
Channels BLE : 0~39 (2 MHz/CH)

Data Rates andLegacy: 3 Mbps data rate; throughput up to 2.17 Mbps **Throughput**BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Electrical Interface

USB 2.0 compliant

Bluetooth Software

Supported

Link Topology

Certifications

Microsoft Windows Bluetooth Software

Power Management

Microsoft Windows ACPI, and USB Bus Support FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management ETS 300 328, ETS 300 826

Certifications Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles Supported

BT4.1-ESR 5/6/7 Compliance

d LE Link Layer Ping

LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy



Technical Specifications

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

POWER

180W active PFC 87/90/87% efficient at 20/50/100% load (115V) **Operating Voltage Range**

88/91/88% efficient at 20/50/100% load (230V)

90 - 264 VAC **Rated Voltage Range**

Rated Line Frequency 50/60 HZ

Operating Line Frequency 47 - 63 Hz

Rated Input Current 180W: 2.5A 180W: 2.5A

Rated Input Current with Energy Efficient* Power

Supply

DC Output +12.1V

Current Leakage (NFPA 99: N/A

2102)

2102)

Current Leakage (NFPA 99: Less than 500 microamps of leakage current at 120 Vac with the ground wire disconnected, as required for Non-patient Electrical Appliances and

Equipment used in a patient care facility or that contact patients in

normal use. Per section 10.3.5.1.

Less than 100 microamps of leakage current at 120 Vac with the ground wire intact with normal polarity, as required for Non-patient Electrical Appliances and Equipment used in a patient care facility or that contact

patients in normal use. Per section 10.3.5.1.

Power Supply Fan N/A

Power cord length 6.0 ft. (1.83 m)



Technical Specifications

COMPATIBILITY

Туре	Description	Part Number
HP EliteOne 1000	HP EliteOne 1000 IR Camera with Rear Webcam	2HW55AA
Accessories	HP EliteOne 1000 23.8in FHD Display*	2SC22AA
	HP EliteOne 1000 23.8in FHD Touch Display*	2SC23AA
	HP EliteOne 1000 27in 4K UHD Display*	2SC24AA
	HP EliteOne 1000 34in WQHD Curved Display*	2SC25AA
Graphics Solutions	HP UHD USB Graphics Adapter	N2U81AA
	HP DisplayPort™ 1.2 Cable Kit	VN567AA
	HP DisplayPort™ 1.2 To DVI-D Adapter	FH973AA
	HP DisplayPort™ 1.2 To VGA Adapter	AS615AA
	HP DisplayPort™ 1.2 To HDMI 4k Adapter	K2K92AA
	HP DisplayPort™ To HDMI True 4k Adapter	2JA63AA
	HP DVI to DVI Cable	DC198A
System Memory	HP 4GB DDR4-2400 SODIMM	Z9H55AA
	HP 8GB DDR4-2400 SODIMM	Z9H56AA
	HP 16GB DDR4-2400 SODIMM	Z9H53AA
Data Storage Drives	HP 256GB SATA TLC Solid State Drive	P1N68AA
	HP 500GB SATA 6G 2.5 (8GB Cache) SSHD Drive	E1C62AA
	HP 512GB Turbo Drive G2 TLC M.2 SSD Drive	X8U75AA
	HP 256GB Turbo Drive Gen2 M.2 SSD Drive	1CA51AA
	Intel® Optane Memory 16GB (cache)	1WV97AA
I/O Devices	HP USB to Serial Adapter	J7B60AA
	HP Type-C to USB3 Adapter	N2Z63AA
Security	HP Keyed Cable Lock 10mm Kit	T1A62AA
Multimedia Devices	HP Business Headset v2	T4E61AA
	HP UC Wireless Duo Headset	W3K09AA
Input Devices	HP USB Business Slim Keyboard	N3R87AA
	HP Wireless Business Slim Keyboard and Mouse**	QY449AA
	HP USB Keyboard and Mouse Healthcare Edition	1VD81AA
	HP USB Business Slim Grey Keyboard (EMEA only)	Z9H49AA
	HP USB Business Slim Smartcard CCID Keyboard	Z9H48AA
	HP USB PS/2 Washable Keyboard and Mouse Kit**	BU207AA
	HP USB Grey V2 Mouse (EMEA only)	Z9H74AA
	HP USB Antimicrobial Slim Keyboard and Mouse	Z9H50AA
	HP USB Hardened Mouse	P1N77AA
	HP USB Mouse	QY777AA
	HP USB 1000dpi Laser Mouse	QY778AA

^{*}Separately purchased, interchangeable displays in sizes 23.8" (60.45 cm), 27" (68.58 cm) and 34" (86.36 cm) diagonal are planned to be available after launch in November



Technical Specifications

Summary of Changes

Date of change:	Version History:	Description of change:
	From V1 to V2	
October 3, 2017	From V2 to V3	Displays specs updated
October 5, 2017	From V3 to V4	DisplayPort™ updated to DisplayPort™ 1.2

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